

LAMP

1259-7SURSYGW/S530-A3



Features

- Two chips are matched for uniform light output, wide viewing angle
- Long life-solid state reliability
- I.C. compatible/Low power consumption
- Pb free
- The product itself will remain within RoHS compliant version

Description

- The 1259-7 LED lamp contain two integral chips and is available as both bicolor and bipolar types.
- The Brilliant Red and Brilliant Yellow Green light is emitted by diodes of AlGaInP and AlGaInP
- Type of bipolar lamps are both White Clear and Color Clear while the bicolor are White Diffused

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Applications

- TV set
- Monitor
- Telephone
- Computer

Device Selection Guide

Chip Materials	Emitted Color	Resin Color	
AlGaInP	Brilliant Red	White Diffused	
AlGaInP	Brilliant Yellow Green		
Absolute Maximum Rating	js (Ta=25)		

Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Ratin	g	Unit
Continuous Forward Connect		SUR/S530	25	
Continuous Forward Current	lF I	SYG/S530	25	mA
Reverse Voltage	V _R	5		V
	Pd	SUR/S530	60	
Power Dissipation		SYG/S530	60	mW
Operating Temperature	T _{opr}	-40 ~ +85		
Storage Temperature	Tstg	-40 ~ +100		
500	ESD _{HBM}	SUR/S530	2000	N.
ESD		SYG/S530	2000	V
Soldering Temperature	T _{sol}	Reflow Soldering : 260 for 5 sec.		

Electro-Optical Characteristics (Ta=25)

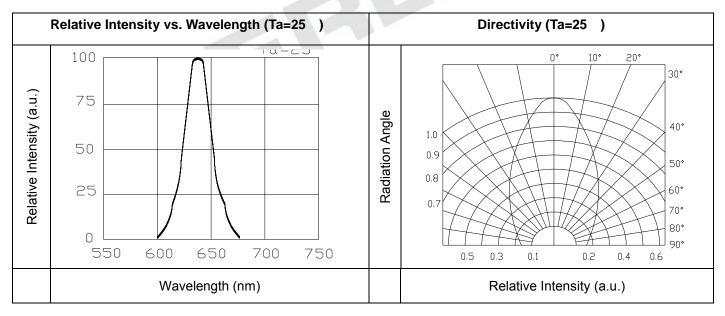
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Parameter		Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	V _F	SUR/S530		2.0	2.4	v	I _F =20mA
		SYG/S530		2.0	2.4		
Reverse Current	I _R	SUR/S530			10	μA	V _R =5V
		SYG/S530			10		
Luminous Intensity	Iv	SUR/S530	40	80		mcd	l _F =20mA
		SYG/S530	16	32			
Viewing Angle		201/2		60		deg	I _F =20mA
Peak Wavelength	р	SUR/S530		632		nm	I _F =20mA
		SYG/S530		575			
Dominant Wavelength	d	SUR/S530		624		nm	I _F =20mA
		SYG/S530		573			
Spectrum Radiation Bandwidth		SUR/S530		20		nm	I _F =20mA
		SYG/S530		20			
Typical Electro-Optical Characteristics Curves							

Typical Electro-Optical Characteristics Curves

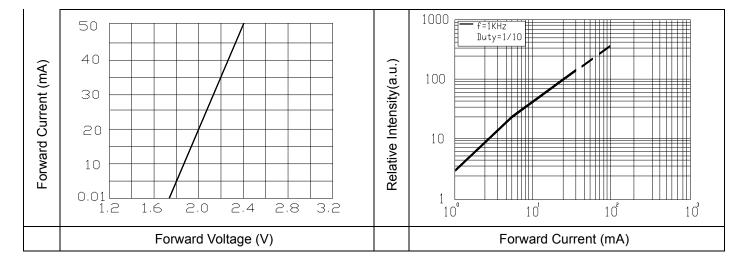
SUR

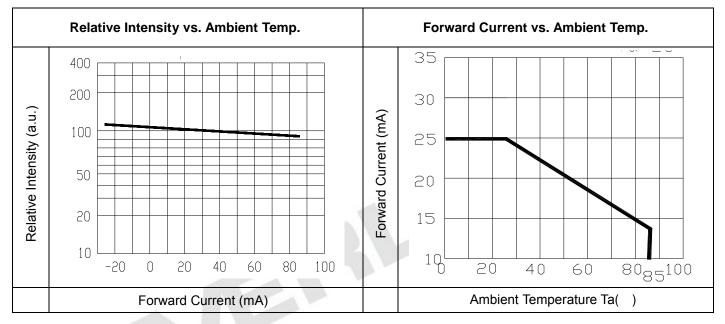


Forward Current vs. Forward Voltage (Ta=25)

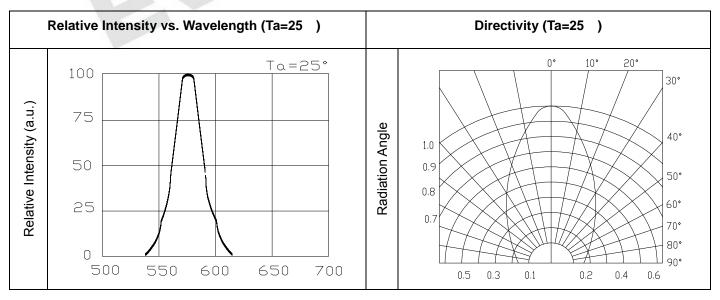
Relative Intensity vs. Forward Current (Ta=25)





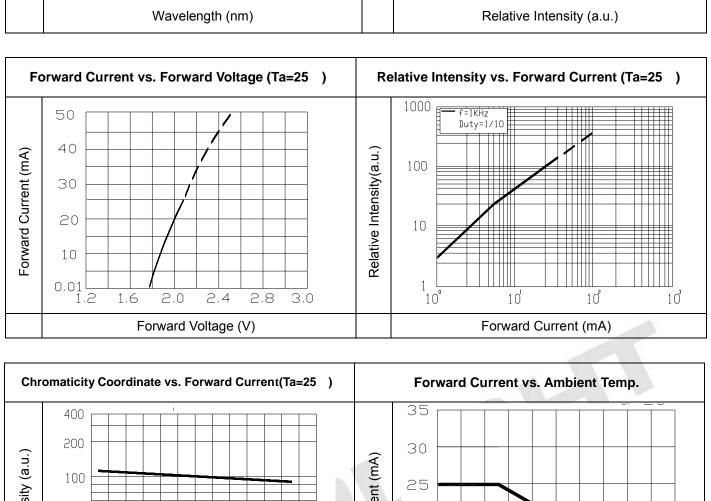


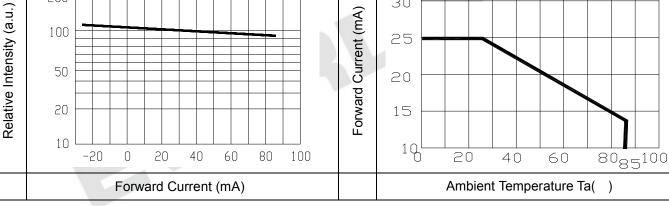
SYG



DATASHEET LAMP 1259-7SURSYGW/S530-A3

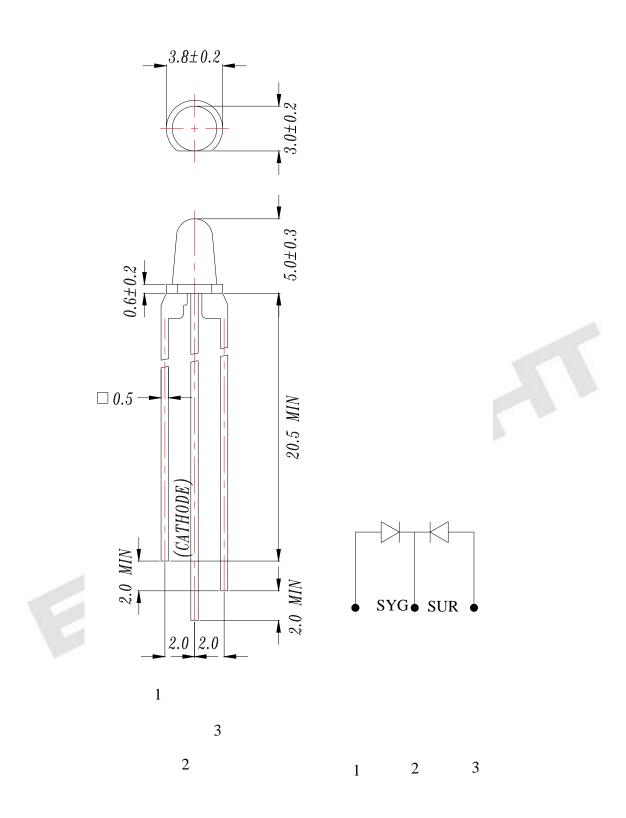
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Package Dimension





Expired Period: Forever

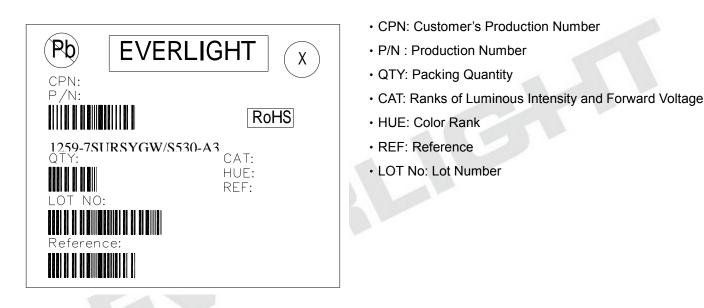


Note: Note:

- 1.All dimensions are in Millimeter.
- 2.An epoxy meniscus may extend about 1.5mm(0.059") down to the lead.
- 3. Tolerances unless Dimension ± 0.25 mm.

Moisture Resistant Packing Materials

Label Explanation

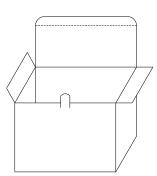


Packing Specification

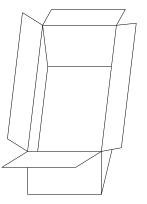
Anti-electrostatic bag







Outside Carton





Packing Quantity

- 1. 500 PCS/1 Bag, 5 Bags/1 Inner Carton
- 2. 10 Inner Cartons/1 Outside Carton

Notes

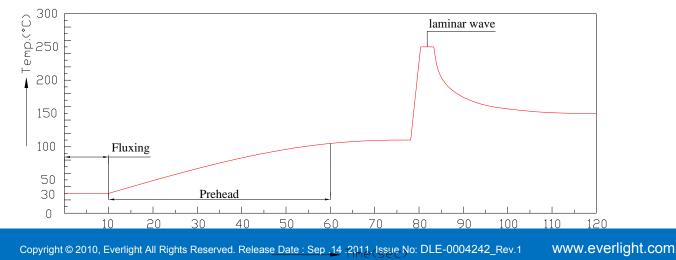
- 1. Lead Forming
 - During lead formation, the leads should be bent at a point at least 3mm from the base of the epoxy bulb.
 - Lead forming should be done before soldering.
 - Avoid stressing the LED package during leads forming. The stress to the base may damage the LED's characteristics or it may break the LEDs.
 - Cut the LED lead frames at room temperature. Cutting the lead frames at high temperatures may cause failure of the LEDs.
 - When mounting the LEDs onto a PCB, the PCB holes must be aligned exactly with the lead position of the LED. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.
- 2. Storage
 - The LEDs should be stored at 30°C or less and 70% RH or less after being shipped from Everlight and

the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.

- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.
- 3. Soldering
 - Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to epoxy bulb, and soldering beyond the base of the tie bar is recommended.
 - Recommended soldering conditions:

Hand Soldering		DIP Soldering			
Temp. at tip of iron	300 Max. (30W	Preheat temp.	100 Max. (60 sec		
	Max.)	r Teneat temp.	Max.)		
Soldering time	3 sec Max.	Bath temp. & time	260 Max., 5 sec Max		
Distance	3mm Min.(From	Distance	3mm Min. (From		
	solder joint to		solder joint to epoxy		
	epoxy bulb)		bulb)		





Recommended soldering profile

Expired Period: Forever

- Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.
- Dip and hand soldering should not be done more than one time
- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- Although the recommended soldering conditions are specified in the above table, dip or hand soldering at the lowest possible temperature is desirable for the LEDs.
- Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.
- 4. Cleaning
 - When necessary, cleaning should occur only with isopropyl alcohol at room temperature for a duration of no more than one minute. Dry at room temperature before use.
 - Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Ultrasonic cleaning shall be pre-qualified to ensure this will not cause damage to the LED
- 5. Heat Management
 - Heat management of LEDs must be taken into consideration during the design stage of LED

application. The current should be de-rated appropriately by referring to the de-rating curve found in each product specification.

- The temperature surrounding the LED in the application should be controlled. Please refer to the data sheet de-rating curve.
- 6. ESD (Electrostatic Discharge)
 - Electrostatic discharge (ESD) or surge current (EOS) can damage LEDs.
 - An ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling LEDs.
 - All devices, equipment and machinery must be properly grounded.
 - Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing.
- 7. Other
 - Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
 - When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply

with the absolute maximum ratings and the instructions included in these specification sheets.

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Expired Period: Forever





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